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TECHNOLOGY CENTER 2800 IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Shields et al.

Assignee: Advanced Micro Devices, Inc.

Title: A SACRIFICIAL TIN ARC LAYER FOR INCREASED PAD ETCH

THROUGHPUT

Serial No.: 09/208,325 Examiner: T. Nguyen Filed: 12/9/98

T. Nguyen Group Art Unit: 2813

Attorney Docket No.: D730 (HDN 1068)

Anthem, Arizona April 24, 2000

COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

CHANGE OF ADDRESS

Sir:

Please change the address of the undersigned attorney of record for the above-identified application to:

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Respectfully submitted,

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Attorney of Record

I certify that this document is being deposited on \(\frac{1}{2000} \) with the U.S. Postal Service as first class mail under 37 C.F.R. \(\) 1.8 addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

Signature

H. D. Nelson

Typed or printed name